

# APPROVAL SHEET

WW08P, WW06P

 $\pm 1\%$ ,  $\pm 5\%$  47m $\Omega$ ~976m $\Omega$ 

High Power Low Ohmic Chip Resistors

Size 0805 1/3W; 0603 1/4W

\*Contents in this sheet are subject to change without prior notice.



#### **FEATURE**

- 1. Small size and light weight
- 2. High reliability and stability
- 3. Reduced size of final equipment
- 4. High precision
- 5. RoHS compliant and Lead free products

#### **APPLICATION**

- High accuracy dc-power supply
- Digital multi-meter
- Telecommunication
- Computer
- Automotive industry
- Medical and military equipment

#### DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is Tin (lead free) alloy.

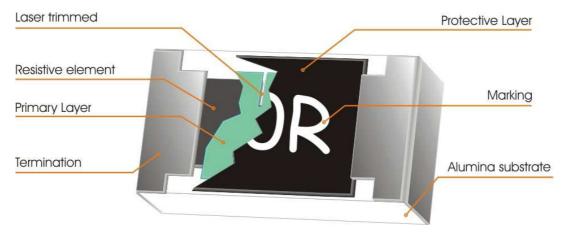


Fig 1. Consctruction of Chip-R



### **QUICK REFERENCE DATA**

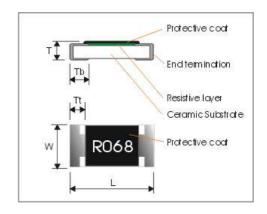
| Item  | General Specification            |                                  |  |  |  |
|---|----------------------------------|----------------------------------|--|--|--|
| Series No.  | WW08P                            | WW06P                            |  |  |  |
| Size code   | 0805 (2012)                      | 0603(1608)                       |  |  |  |
| Resistance Tolerance  | ±1%, ±5%                         |                                  |  |  |  |
| Resistance Range  | 0.047Ω~0.976Ω(E96+E24 series)    |                                  |  |  |  |
| TCR (ppm/°C) -55°C ~ +155°C<br>0.047Ω~0.091Ω<br>0.100Ω~0.976Ω | ≤ ± 200 ppm/°C<br>≤ ± 150 ppm/°C | ≤ ± 250 ppm/°C<br>≤ ± 200 ppm/°C |  |  |  |
| Max. dissipation at T <sub>amb</sub> =70°C                    | 1/3 W                            | 1/4 W                            |  |  |  |
| Max. Operation Voltage (DC or RMS)                            | 150V                             | 50V                              |  |  |  |
| Max. Overload Voltage (DC or RMS)                             | 300V                             | 100V                             |  |  |  |
| Climatic category (IEC 60068)                                 | 55/155.                          | /56                              |  |  |  |
| Basic specification JIS C 5201-1:1998 / IEC 60068-2-58:2004   |                                  |                                  |  |  |  |

#### Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by  $RCWV = \sqrt{Rated \, Power \times Resistance \, Value} \, \, \text{or Max. RCWV listed above, whichever is lower.}$

## **DIMENSIONS(unit:mm)**

| Part No | WW08P           | WW06P           |
|---------|-----------------|-----------------|
| L       | $2.00 \pm 0.10$ | 1.60 ± 0.10     |
| W       | $1.25 \pm 0.10$ | $0.80 \pm 0.10$ |
| Т       | $0.50 \pm 0.15$ | 0.45 ± 0.15     |
| Tb      | $0.40 \pm 0.20$ | $0.30 \pm 0.15$ |
| Tt      | $0.40 \pm 0.20$ | $0.30 \pm 0.10$ |



## **MARKING**

Each resistor is marked with a three-digit(WW06P  $\pm 1\%;\pm 5\%$ ) or four-digit(WW08P  $\pm 1\%;\pm 5\%$ ) code on the protective coating to designate the nominal resistance value.

- \* Remark : 0603 resistor value from  $0.1\Omega$  to  $0.976\Omega$  E48/E96 series use 2 significant digits followed by letter.(Example R560 = R56 ; R402= 59Z)
- \*\* Remark : 0603 resistor value from  $0.047\Omega$  to  $0.091\Omega$  use the last Two-digits followed by "M" equals "m", means 1/1000(Example R047 = 47M ; R050= 50M)

## **Rated Resistance**

| Resistance | Code | Code | Resistance | Code | Code | Resistance | Code | Code                     | Resistance | Code | Code |
|------------|------|------|------------|------|------|------------|------|--------------------------|------------|------|------|
| Resistance | 0805 | 0603 | Resistance | 0805 | 0603 | Resistance | 0805 | 0805   0603   Resistance | 0805       | 0603 |      |
| 47mΩ       | R047 | 47M  | 56mΩ       | R056 | 56M  | 68mΩ       | R068 | 68M                      | 82mΩ       | R082 | 82M  |
| 50mΩ       | R050 | 50M  | 60mΩ       | R060 | 60M  | 70mΩ       | R070 | 70M                      | 85mΩ       | R085 | 85M  |
| 51mΩ       | R051 | 51M  | 62mΩ       | R062 | 62M  | 75mΩ       | R075 | 75M                      | 90mΩ       | R090 | 90M  |
| 55mΩ       | R055 | 55M  | 65mΩ       | R065 | 65M  | 80mΩ       | R080 | 80M                      | 91mΩ       | R091 | 91M  |



#### **FUNCTIONAL DESCRIPTION**

#### Product characterization

Standard values of nominal resistance are taken from the E96&E24 series for resistors with a tolerance of  $\pm 1\%, \pm 5\%$ . The values of the E96/E24 series are in accordance with "IEC publication 60063".

## **Derating**

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

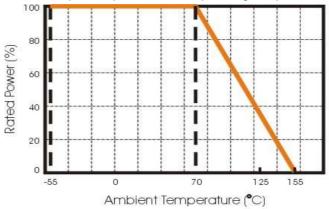


Fig. 2 Maximum dissipation in percentage of rated power As a function of the ambient temperature

#### **MOUNTING**

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

#### **SOLDERING CONDITION**

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

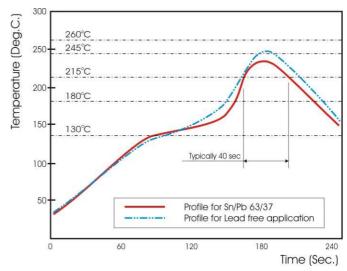


Fig 3. Infrared soldering profile for Chip Resistors



# **CATALOGUE NUMBERS**

The resistors have a catalogue number starting with.

| WW08       | Р                                  | R050   | F         | Т                           | L                |  |
|------------|------------------------------------|--|-----------|-----------------------------|------------------|--|
| Size code  | Type code                          | Resistance code  | Tolerance | Packaging code              | Termination code |  |
| WW08: 0805 | P :Power                           | E96+E24:   | J : ±5%   | T: 7" Reeled taping         | L = Sn base      |  |
| WW06: 0603 | 0805 size=0.33W<br>0603 size=0.25W | "R" is first digit followed by 3 significant digits.(0805) | F : ±1%   | paper taping<br>5Kpcs/reel. | (lead free)      |  |
|            |                                    | $50m\Omega$ =R050  |           | 011p00/1001.                |                  |  |
|            |                                    | $510m\Omega$ =R510   |           |                             |                  |  |
|            |                                    | "R" is first digit followed by 2                           |           |                             |                  |  |
|            |                                    | Significant digit.(0603)                                   |           |                             |                  |  |
|            |                                    | $100m\Omega = R10$   |           |                             |                  |  |
|            |                                    | 510mΩ =R51   |           |                             |                  |  |
|            |                                    | 0603 0.1Ω~0.976Ω E48/E96                                   |           |                             |                  |  |
|            |                                    | 2 significant digits followed by letter                    |           |                             |                  |  |
|            |                                    | 0603 0.047Ω~0.091Ω E24                                     |           |                             |                  |  |
|            |                                    | 2 significant digits followed by M $(M=milli\ \Omega)$ .   |           |                             |                  |  |
|            |                                    | (R047=47m)   |           |                             |                  |  |

■ Reeled tape packaging : 8mm width paper taping 5000pcs per 7" reel.



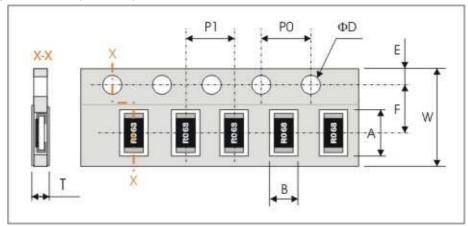
# **TEST AND REQUIREMENTS**

Basic specification: JIS C 5201-1: 1998

| TEST   | PROCEDURE  | REQUIREMENT   |
|--|--|---|
| Clause 4.8 Temperature Coefficient of Resistance (TCR) | Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\!\!\times\!10^6 \text{ (ppm/°C)}$ $R_1: \text{Resistance at reference temperature}$ $R_2: \text{Resistance at test temperature}$ $t_1: 20^\circ\!\text{C}+5^\circ\!\text{C}-1^\circ\!\text{C}.$ | Refer to quick reference data for T.C.R specification   |
| Clause 4.13 Short time overload                        | 5.0x Rated power or Max. Overload Voltage for 5 sec. Measure resistance after 30 minutes.  | $\Delta$ R/R max. J: $\leq$ ±(2%+0.5m $\Omega$ ) F: $\leq$ ±(1%+0.5m $\Omega$ )   |
| Clause 4.18 Resistance to soldering heat(R.S.H)        | Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C±5°C.   | No visible damage $ \Delta R/R \text{ max. J:} \leq \pm (1\% + 0.5 \text{m}\Omega) $ $ F: \leq \pm (0.5\% + 0.5 \text{m}\Omega) $ |
| Clause4.17<br>Solderability                            | Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235 $^\circ\!$   | Good tinning (>95% covered) No visible damage   |
| Clause 4.19 Temperature cycling                        | <ol> <li>30 minutes at -55°C±3°C,</li> <li>2~3 minutes at 20℃+5℃-1℃,</li> <li>30 minutes at +155°±3°C,</li> <li>2~3 minutes at 20℃+5℃-1℃,</li> <li>Total 5 continuous cycles.</li> </ol>   | No visible damage $ \Delta R/R \text{ max. } J \leqq \pm (1\% + 1 m\Omega) $ $ F \leqq \pm (0.5\% + 1 m\Omega) $                  |
| Clause 4.25<br>Load life (endurance)                   | 1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off.  | No visible damage $ \Delta R/R \text{ max. } J \leqq \pm (3\% + 0.5 \text{m}\Omega) $ $ F \leqq \pm (1\% + 0.5 \text{m}\Omega) $  |
| Clause 4.24<br>Load life in Humidity                   | 1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off.  | No visible damage $ \Delta R/R \text{ max. } J \leqq \pm (3\% + 0.5 \text{m}\Omega) $ $ F \leqq \pm (1\% + 0.5 \text{m}\Omega) $  |
| Clause 4.33<br>Bending strength                        | Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 3 mm, once for 10 seconds.   | No visible damage $ \Delta R/R \text{ max. } J \leqq \pm (1\% + 1 m\Omega) $ $ F \leqq \pm (0.5\% + 1 m\Omega) $                  |
| Clause 4.32<br>Adhesion                                | Pressurizing force: 5N, Test time: 10±1sec.  | No remarkable damage or removal of the terminations   |
| Clause 4.6<br>Insulation Resistance                    | Apply the maximum overload voltage (DC) for 1minute.   | R≥10GΩ  |
| Clause 4.7 Dielectric Withstand Voltage                | Apply the maximum overload voltage (AC) for 1 minute.  | No breakdown or flashover   |

# **PACKAGING**

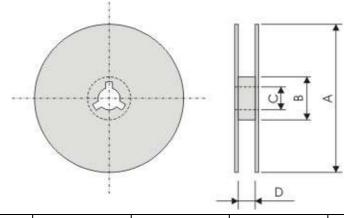
Paper Tape specifications (unit:mm)



| Series No. | А         | В         | W         | F         | E         |
|------------|-----------|-----------|-----------|-----------|-----------|
| WW06P      | 1.90±0.20 | 1.10±0.20 | 8.00±0.30 | 3.50±0.20 | 1.75±0.10 |
| WW08P      | 2.40±0.20 | 1.65±0.20 | 8.00±0.30 | 3.50±0.20 | 1.75±0.10 |

| Series No. | P1        | P0        | ΦD                           | Т         |
|------------|-----------|-----------|------------------------------|-----------|
| WW06P      | 4.00±0.10 | 4.00±0.10 | $\Phi$ 1.50 $^{+0.1}_{-0.0}$ | 0.65±0.05 |
| WW08P      | 4.00±0.10 |           |                              | Max. 1.0  |

# **Reel dimensions**



| Symbol      | Α          | В         | С        | D       |
|-------------|------------|-----------|----------|---------|
| (unit : mm) | Φ178.0±2.0 | Φ60.0±1.0 | 13.0±0.2 | 9.0±0.5 |

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